


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	COOLING MODULE OF COMPUTER SYSTEM AND RELATED APPARATUS WITH AIR WALL FOR PREVENTING RECYCLING OF HEATED AIR		
Application Type :		regular, utility	
Attorney Docket Number :		WISP0048USA	
Correspondence address:			
Customer Number:		027765	
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.